

*Institute of Environmental Sciences and Technology*

IEST-RP-PR001.2

Product Reliability Division  
Recommended Practice 001.2

# **Management and Technical Guidelines for the Environmental Stress Screening (ESS) Process**



Arlington Place One  
2340 S. Arlington Heights Road, Suite 620  
Arlington Heights, IL 60005-4510  
Phone: (847) 981-0100 • Fax: (847) 981-4130  
E-mail: [information@iest.org](mailto:information@iest.org) • Web: [www.iest.org](http://www.iest.org)

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This Recommended Practice was prepared by and is under the jurisdiction of Working Group 001 of the IEST Product Reliability Division (WG-PR001). The following WG voting members contributed to the development of this edition of this Recommended Practice.

William T. Boswell, WG-PR001 Chair, Consultant

Dustin S. Aldridge, Raytheon Missile Systems

Christine L. Peterson, C. Hanse Industries

Michael A. Roy, Consultant

David M. Sgro, FLIR

The Working Group also wishes to acknowledge the contributions of members who prefer to remain anonymous.

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# Management and Technical Guidelines for the Environmental Stress Screening (ESS) Process

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# Management and Technical Guidelines for the Environmental Stress Screening (ESS) Process

## IEST-RP-PR001.2

### 1 SCOPE AND LIMITATIONS

#### 1.1 Scope

This Recommended Practice (RP) supersedes IEST-RP-PR001.1, *Management and Technical Guidelines for the ESS Process* (1999). This RP provides an overview of the techniques and considerations needed to define a viable Environmental Stress Screening (ESS) program. This RP uses language that can be used by the military, government, and commercial communities.

This RP is intended to be an important tool that can be used by the electronics industry for conducting ESS. This document applies to a knowledgeable ESS practitioner as well as to those individuals who are new to ESS. Additionally, it provides the practitioner all of the tools required to successfully plan, develop, and implement a viable ESS program.

The process elements required to successfully implement ESS are discussed in this document, as well as those process steps necessary to keep the ESS process dynamic; i.e., successful planning, implementation of ESS, the collection of failure data, the analysis of failures, and implementation of corrective action.

It is not the intent of this document to describe engineering development or formal verification environmental tests. These subjects are valuable parts of the product development process, but because of their depth and complexity are beyond the scope of this document.

Rather, this document describes the application of thermal, vibration, and electrical performance as forcing functions during the ESS process because of their nearly universal utility. However, other types of forcing functions (such as pressure cycling) or performance evaluation (X-ray and infrared scanning, for example) may be appropriate in special circumstances for particular products. This document should not be construed as discouraging the application of other relevant forcing functions when appropriate.

This document stresses the need to expose product to forcing functions as early in the life of the product as possible. This will assist in producing the best product possible given requisite economic considerations.

It is recognized that a product will likely be composed of several different assemblies. As these assemblies are integrated and the product becomes more and more complex, the level of environmental loading that the lower level assemblies may experience can be greatly attenuated (i.e., thermal path restrictions and vibration dampening). With this in mind, and realizing that all assemblies are prone to process anomalies, this document emphasizes the need to perform ESS at the lowest practical assembly level.

This RP discusses the screening environments of temperature cycling, random vibration, and power cycling. For each of these environments, a discussion of the steps required to successfully incorporate them into the ESS program